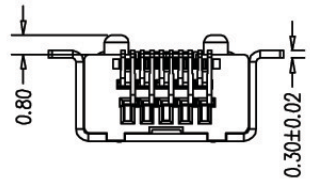

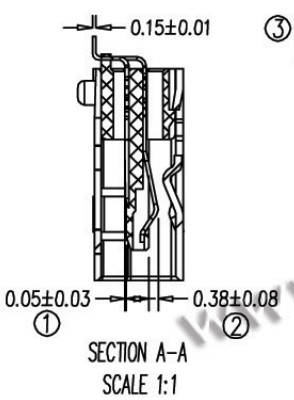

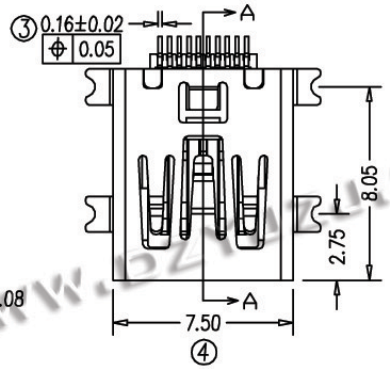

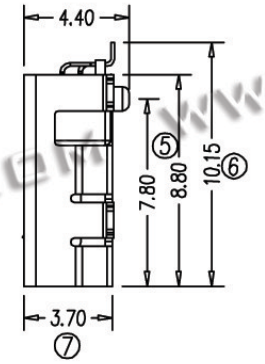

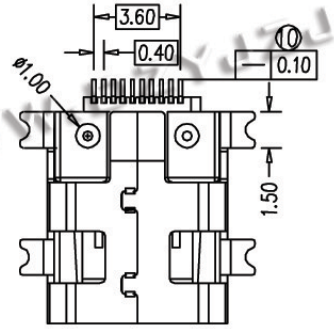

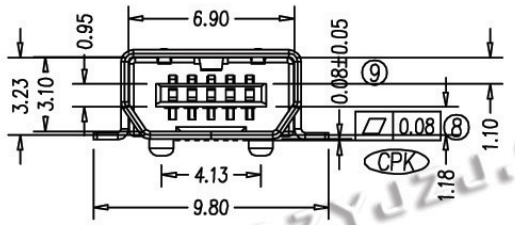

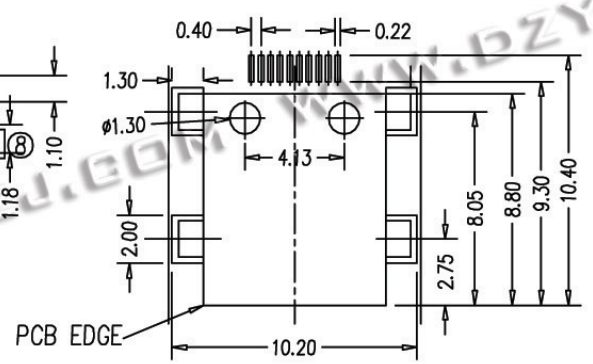

RECOMMANDED PCB LAYOUT

备注:
1.材质:
1.1胶芯：LCP UL94V-0
1.2端子：C5191,镍底50μ″，镀金1μ″或3μ″
1.3外壳：C2680，镍底50μ″，镀雾锡80μ″以上或外壳镀全镍80μ″以上
2.主要特性:
2.1额定电流：1.0A
2.2接触阻抗：50mΩ MAX
2.3绝缘阻抗：100MΩ MIN 100V DC
2.4耐压测试：100V AC
2.5沾锡性：温度235±5℃，时间5±0.5s
2.6整体插入力：3.57kgf MAX 整体拔出力:0.71kgf MIN
2.7使用寿命：5000次
2.8耐温性:烤箱测试：温度250±5℃，时间2分钟
2.9工作环境：温度：-30℃～+80℃；湿度：80% MAX
3.圆圈标记尺寸表示重点检验尺寸 ,CPK值不小于1.33。

深圳市华宇创精密电子有限公司

TOLERANCE: X.X ±0.30 X.XX ±0.25 X.XXX ±0.15 X.° ±2° X.X° ±0.5°	DRAWED BY : 陈一鸣	DATE : 2014-02-23	PART NAME: MINI USB 10PIN SMT TYPE	
	CHECKED BY: 马跃	DATE : 2014-02-23	PART NO.	HYC25-USBC05-105
			MOLD NO.	
UNIT: mm [inch]	APPROVED BY: 邱国夷	DATE : 2014-02-23	DRAW NO:	HYC-USB15112510
SCALE:1:1 SIZE: A4			SHEET NO.	1 OF 1